#### THIN SMD LOW/MEDIUM-FREQUENCY CRYSTAL UNIT

# **MC-146**

- High-density mounting-type SMD of 1.4mm thickness.
- Small packaging area and light weight.
- Excellent shock resistance and environmental capability.
- Most suitable for small communications devices.



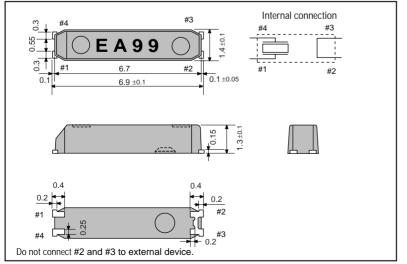
#### **■** Specifications (characteristics)

Item		Symbol	Specifications		Remarks
Nominal frequency		f	32.768kHz	75.000kHz	please contact us for inquiries about usable frequencies
Temperature range	Storage temperature	Tstg	-55°C to +125°C		
	Operating temperature	Topr	-40°C to +85°C		
Maximum drive level		GL	1.0μW max.		Operating drive level 0.5µW max.
Soldering condition		Tsol	Twice at under 260°C within 10 sec. or under 230°C within 3 min.		
Frequency tolerance(standard)		Δf/f	±20ppm, ±50ppm		Ta=25°C, DL=0.1μW
Peak temperature(frequency)		θТ	251	C ±5°C	
Temperature coefficient(frequency)		a	-0.04ppm/*C² max.		
Load capacitance		CL	6pF to ∞		Please specify
Series resistance		R <sub>1</sub>	65 kΩ max.	30kΩ max.	
Motional capacitance		C <sub>1</sub>	1.9fF typ.		
Shunt capacitance		Co	0.8pF typ.		
Insulation resistance		IR	500 MΩ min.		
Aging		fa	±3ppm/year max.		Ta=25°C ±3°C, first year
Shock resistance		S.R.	±5pp	m max.	Three drops on a hard board from 75 cm or excitation test with 3000G x 0.3ms x 1/2 sine wave x 3 directions

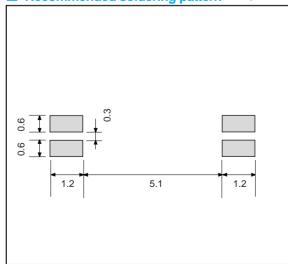
(Unit: mm)

Metal may be exposed on the top of this product. This won't affect any quality, reliability or electrical spec.

#### External dimensions



### Recommended soldering pattern (Unit: mm)



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## THE CRYSTALMASTER



EPSON offers effective savings to its customers through a wide range of electronic devices, such as semiconductors, liquid crystal display (LCD) modules, and crystal devices. These savings are achieved through a sophisticated melding of three different efficiency technologies.

Power saving technology provides low power consumption at low voltages.

Space saving technology provides further reductions in product size and weight through super-precise processing and high-density assembly technology.

Time saving technology shortens the time required for design and development on the customer side and shortens delivery times.



Our concept of Energy Saving technology conserves resources by blending the essence of these three efficiency technologies. The essence of these technologies is represented in each of the products that we provide to our cus-

In the industrial sector, leading priorities include measures to counter the greenhouse effect by reducing CO2,

measures to preserve the global environ-

ment, and the development of energyefficient products. Environmental problems are of global concern, and although the contribution of energysaving technology developed by EPSON may appear insignificant, we seek to contribute to the develop-

ment of energy-saving products by our

customers through the utilization of our electronic devices. EPSON is committed to the conservation of energy, both for the sake of people and of the planet on which we live.





Resource

Saving



SEIKO EPSON CORP. QUARTZ DEVICE DIVISION acquired ISO9001 and ISO14001 certification by B.V.Q.I. (Bureau Veritas Quality International) .

> ISO9001 in October, 1992. ISO14001 in November, 1997.

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